

# STARPOWER

SEMICONDUCTOR

**IGBT**

## GD450MLS65F6S

**650V/450A 3-level in one-package**

### General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as 3-level-application.

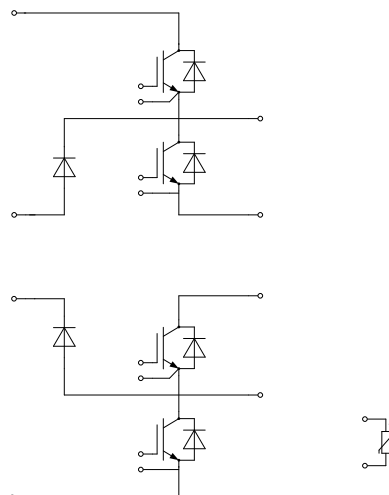
### Features

- Low  $V_{CE(sat)}$  Trench IGBT technology
- $V_{CE(sat)}$  with positive temperature coefficient
- Maximum junction temperature 175 °C
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

### Typical Applications

- Solar power
- 3-level-application

### Equivalent Circuit Schematic



**Absolute Maximum Ratings**  $T_C=25^{\circ}\text{C}$  unless otherwise noted**Q1/Q4 IGBT**

| Symbol    | Description   | Value    | Unit |
|-----------|---|----------|------|
| $V_{CES}$ | Collector-Emitter Voltage                             | 650      | V    |
| $V_{GES}$ | Gate-Emitter Voltage                                  | $\pm 20$ | V    |
| $I_C$     | Collector Current @ $T_C=80^{\circ}\text{C}$          | 305      | A    |
| $I_{CM}$  | Pulsed Collector Current $t_p=1\text{ms}$             | 900      | A    |
| $P_D$     | Maximum Power Dissipation @ $T_j=175^{\circ}\text{C}$ | 955      | W    |

**Q2/Q3 IGBT**

| Symbol    | Description   | Value    | Unit |
|-----------|---|----------|------|
| $V_{CES}$ | Collector-Emitter Voltage                             | 650      | V    |
| $V_{GES}$ | Gate-Emitter Voltage                                  | $\pm 20$ | V    |
| $I_C$     | Collector Current @ $T_C=80^{\circ}\text{C}$          | 270      | A    |
| $I_{CM}$  | Pulsed Collector Current $t_p=1\text{ms}$             | 750      | A    |
| $P_D$     | Maximum Power Dissipation @ $T_j=175^{\circ}\text{C}$ | 842      | W    |

**D1-D4 Diode**

| Symbol    | Description   | Value | Unit |
|-----------|---|-------|------|
| $V_{RRM}$ | Repetitive Peak Reverse Voltage                             | 650   | V    |
| $I_F$     | Diode Continuous Forward Current @ $T_C=80^{\circ}\text{C}$ | 130   | A    |
| $I_{FM}$  | Diode Maximum Forward Current $t_p=1\text{ms}$              | 500   | A    |

**D5,D6 Diode**

| Symbol    | Description   | Value | Unit |
|-----------|---|-------|------|
| $V_{RRM}$ | Repetitive Peak Reverse Voltage                             | 650   | V    |
| $I_F$     | Diode Continuous Forward Current @ $T_C=80^{\circ}\text{C}$ | 305   | A    |
| $I_{FM}$  | Diode Maximum Forward Current $t_p=1\text{ms}$              | 1000  | A    |

**Module**

| Symbol     | Description  | Value       | Unit               |
|------------|--|-------------|--------------------|
| $T_{jmax}$ | Maximum Junction Temperature                             | 175         | $^{\circ}\text{C}$ |
| $T_{jop}$  | Operating Junction Temperature                           | -40 to +150 | $^{\circ}\text{C}$ |
| $T_{STG}$  | Storage Temperature Range                                | -40 to +125 | $^{\circ}\text{C}$ |
| $V_{ISO}$  | Isolation Voltage RMS, $f=50\text{Hz}$ , $t=1\text{min}$ | 3200        | V                  |

**Q1/Q4 IGBT Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

| Symbol        | Parameter                               | Test Conditions  | Min. | Typ. | Max. | Unit          |
|---------------|---|--|------|------|------|---------------|
| $V_{CE(sat)}$ | Collector to Emitter Saturation Voltage | $I_C=450\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$   |      | 1.45 | 1.90 | V             |
|               |   | $I_C=450\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$  |      | 1.60 |      |               |
|               |   | $I_C=450\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$  |      | 1.65 |      |               |
| $V_{GE(th)}$  | Gate-Emitter Threshold Voltage          | $I_C=7.20\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$   | 4.4  | 5.0  | 5.6  | V             |
| $I_{CES}$     | Collector Cut-Off Current               | $V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$   |      |      | 1.0  | mA            |
| $I_{GES}$     | Gate-Emitter Leakage Current            | $V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$   |      |      | 400  | nA            |
| $R_{Gint}$    | Internal Gate Resistance                |  |      | 0.8  |      | $\Omega$      |
| $C_{ies}$     | Input Capacitance                       |  |      | 30.3 |      | nF            |
| $C_{oes}$     | Output Capacitance                      | $V_{CE}=25\text{V}, f=100\text{kHz}, V_{GE}=0\text{V}$   |      | 1.33 |      | nF            |
| $C_{res}$     | Reverse Transfer Capacitance            |  |      | 0.49 |      | nF            |
| $Q_G$         | Gate Charge                             | $V_{GE}=-15\dots+15\text{V}$   |      | 2.77 |      | $\mu\text{C}$ |
| $t_{d(on)}$   | Turn-On Delay Time                      | $V_{CC}=400\text{V}, I_C=100\text{A}, R_G=4.7\Omega, V_{GE}=-5\text{V}/+15\text{V}, T_j=25^\circ\text{C}$  |      | 90   |      | ns            |
| $t_r$         | Rise Time                               |  |      | 50   |      | ns            |
| $t_{d(off)}$  | Turn-Off Delay Time                     |  |      | 768  |      | ns            |
| $t_f$         | Fall Time                               |  |      | 36   |      | ns            |
| $E_{on}$      | Turn-On Switching Loss                  |  |      | 3.70 |      | mJ            |
| $E_{off}$     | Turn-Off Switching Loss                 |  |      | 0.57 |      | mJ            |
| $t_{d(on)}$   | Turn-On Delay Time                      | $V_{CC}=400\text{V}, I_C=100\text{A}, R_G=4.7\Omega, V_{GE}=-5\text{V}/+15\text{V}, T_j=125^\circ\text{C}$ |      | 94   |      | ns            |
| $t_r$         | Rise Time                               |  |      | 60   |      | ns            |
| $t_{d(off)}$  | Turn-Off Delay Time                     |  |      | 829  |      | ns            |
| $t_f$         | Fall Time                               |  |      | 37   |      | ns            |
| $E_{on}$      | Turn-On Switching Loss                  |  |      | 4.87 |      | mJ            |
| $E_{off}$     | Turn-Off Switching Loss                 |  |      | 0.72 |      | mJ            |
| $t_{d(on)}$   | Turn-On Delay Time                      | $V_{CC}=400\text{V}, I_C=100\text{A}, R_G=4.7\Omega, V_{GE}=-5\text{V}/+15\text{V}, T_j=150^\circ\text{C}$ |      | 97   |      | ns            |
| $t_r$         | Rise Time                               |  |      | 61   |      | ns            |
| $t_{d(off)}$  | Turn-Off Delay Time                     |  |      | 841  |      | ns            |
| $t_f$         | Fall Time                               |  |      | 41   |      | ns            |
| $E_{on}$      | Turn-On Switching Loss                  |  |      | 5.20 |      | mJ            |
| $E_{off}$     | Turn-Off Switching Loss                 |  |      | 0.80 |      | mJ            |

**Q2/Q3 IGBT Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

| Symbol        | Parameter                               | Test Conditions  | Min. | Typ. | Max. | Unit          |
|---------------|---|--|------|------|------|---------------|
| $V_{CE(sat)}$ | Collector to Emitter Saturation Voltage | $I_C=375\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$   |      | 1.45 | 1.90 | V             |
|               |   | $I_C=375\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$  |      | 1.60 |      |               |
|               |   | $I_C=375\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$  |      | 1.65 |      |               |
| $V_{GE(th)}$  | Gate-Emitter Threshold Voltage          | $I_C=6.00\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$   | 4.4  | 5.0  | 5.6  | V             |
| $I_{CES}$     | Collector Cut-Off Current               | $V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$   |      |      | 1.0  | mA            |
| $I_{GES}$     | Gate-Emitter Leakage Current            | $V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$   |      |      | 400  | nA            |
| $R_{Gint}$    | Internal Gate Resistance                |  |      | 1.0  |      | $\Omega$      |
| $C_{ies}$     | Input Capacitance                       |  |      | 25.2 |      | nF            |
| $C_{oes}$     | Output Capacitance                      | $V_{CE}=25\text{V}, f=100\text{kHz}, V_{GE}=0\text{V}$   |      | 1.11 |      | nF            |
| $C_{res}$     | Reverse Transfer Capacitance            |  |      | 0.41 |      | nF            |
| $Q_G$         | Gate Charge                             | $V_{GE}=-15\dots+15\text{V}$   |      | 2.31 |      | $\mu\text{C}$ |
| $t_{d(on)}$   | Turn-On Delay Time                      | $V_{CC}=400\text{V}, I_C=100\text{A}, R_G=4.7\Omega, V_{GE}=-5\text{V}/+15\text{V}, T_j=25^\circ\text{C}$  |      | 90   |      | ns            |
| $t_r$         | Rise Time                               |  |      | 45   |      | ns            |
| $t_{d(off)}$  | Turn-Off Delay Time                     |  |      | 664  |      | ns            |
| $t_f$         | Fall Time                               |  |      | 23   |      | ns            |
| $E_{on}$      | Turn-On Switching Loss                  |  |      | 2.63 |      | mJ            |
| $E_{off}$     | Turn-Off Switching Loss                 |  |      | 0.62 |      | mJ            |
| $t_{d(on)}$   | Turn-On Delay Time                      | $V_{CC}=400\text{V}, I_C=100\text{A}, R_G=4.7\Omega, V_{GE}=-5\text{V}/+15\text{V}, T_j=125^\circ\text{C}$ |      | 90   |      | ns            |
| $t_r$         | Rise Time                               |  |      | 52   |      | ns            |
| $t_{d(off)}$  | Turn-Off Delay Time                     |  |      | 726  |      | ns            |
| $t_f$         | Fall Time                               |  |      | 20   |      | ns            |
| $E_{on}$      | Turn-On Switching Loss                  |  |      | 3.11 |      | mJ            |
| $E_{off}$     | Turn-Off Switching Loss                 |  |      | 0.79 |      | mJ            |
| $t_{d(on)}$   | Turn-On Delay Time                      | $V_{CC}=400\text{V}, I_C=100\text{A}, R_G=4.7\Omega, V_{GE}=-5\text{V}/+15\text{V}, T_j=150^\circ\text{C}$ |      | 90   |      | ns            |
| $t_r$         | Rise Time                               |  |      | 54   |      | ns            |
| $t_{d(off)}$  | Turn-Off Delay Time                     |  |      | 736  |      | ns            |
| $t_f$         | Fall Time                               |  |      | 22   |      | ns            |
| $E_{on}$      | Turn-On Switching Loss                  |  |      | 3.17 |      | mJ            |
| $E_{off}$     | Turn-Off Switching Loss                 |  |      | 0.82 |      | mJ            |

**D1-D4 Diode Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

| Symbol    | Parameter                     | Test Conditions  | Min. | Typ. | Max. | Unit          |
|-----------|-------------------------------|--|------|------|------|---------------|
| $V_F$     | Diode Forward Voltage         | $I_F=200\text{A}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$  |      | 1.60 | 2.05 | V             |
|           |                               | $I_F=200\text{A}, V_{GE}=0\text{V}, T_j=125^\circ\text{C}$   |      | 1.65 |      |               |
|           |                               | $I_F=200\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$   |      | 1.65 |      |               |
| $Q_r$     | Recovered Charge              | $V_R=400\text{V}, I_F=100\text{A},$<br>$-di/dt=3100\text{A}/\mu\text{s}, V_{GE}=-5\text{V}$<br>$T_j=25^\circ\text{C}$  |      | 2.63 |      | $\mu\text{C}$ |
| $I_{RM}$  | Peak Reverse Recovery Current |  |      | 80   |      | A             |
| $E_{rec}$ | Reverse Recovery Energy       |  |      | 0.46 |      | mJ            |
| $Q_r$     | Recovered Charge              | $V_R=400\text{V}, I_F=100\text{A},$<br>$-di/dt=3200\text{A}/\mu\text{s}, V_{GE}=-5\text{V}$<br>$T_j=125^\circ\text{C}$ |      | 4.71 |      | $\mu\text{C}$ |
| $I_{RM}$  | Peak Reverse Recovery Current |  |      | 102  |      | A             |
| $E_{rec}$ | Reverse Recovery Energy       |  |      | 1.19 |      | mJ            |
| $Q_r$     | Recovered Charge              | $V_R=400\text{V}, I_F=100\text{A},$<br>$-di/dt=3200\text{A}/\mu\text{s}, V_{GE}=-5\text{V}$<br>$T_j=150^\circ\text{C}$ |      | 5.53 |      | $\mu\text{C}$ |
| $I_{RM}$  | Peak Reverse Recovery Current |  |      | 108  |      | A             |
| $E_{rec}$ | Reverse Recovery Energy       |  |      | 1.42 |      | mJ            |

**D5,D6 Diode Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

| Symbol    | Parameter                     | Test Conditions  | Min. | Typ. | Max. | Unit          |
|-----------|-------------------------------|--|------|------|------|---------------|
| $V_F$     | Diode Forward Voltage         | $I_F=500\text{A}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$  |      | 1.60 | 2.05 | V             |
|           |                               | $I_F=500\text{A}, V_{GE}=0\text{V}, T_j=125^\circ\text{C}$   |      | 1.65 |      |               |
|           |                               | $I_F=500\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$   |      | 1.65 |      |               |
| $Q_r$     | Recovered Charge              | $V_R=400\text{V}, I_F=100\text{A},$<br>$-di/dt=3220\text{A}/\mu\text{s}, V_{GE}=-5\text{V}$<br>$T_j=25^\circ\text{C}$  |      | 3.68 |      | $\mu\text{C}$ |
| $I_{RM}$  | Peak Reverse Recovery Current |  |      | 100  |      | A             |
| $E_{rec}$ | Reverse Recovery Energy       |  |      | 0.62 |      | mJ            |
| $Q_r$     | Recovered Charge              | $V_R=400\text{V}, I_F=100\text{A},$<br>$-di/dt=3350\text{A}/\mu\text{s}, V_{GE}=-5\text{V}$<br>$T_j=125^\circ\text{C}$ |      | 8.00 |      | $\mu\text{C}$ |
| $I_{RM}$  | Peak Reverse Recovery Current |  |      | 142  |      | A             |
| $E_{rec}$ | Reverse Recovery Energy       |  |      | 1.59 |      | mJ            |
| $Q_r$     | Recovered Charge              | $V_R=400\text{V}, I_F=100\text{A},$<br>$-di/dt=3360\text{A}/\mu\text{s}, V_{GE}=-5\text{V}$<br>$T_j=150^\circ\text{C}$ |      | 9.57 |      | $\mu\text{C}$ |
| $I_{RM}$  | Peak Reverse Recovery Current |  |      | 152  |      | A             |
| $E_{rec}$ | Reverse Recovery Energy       |  |      | 1.83 |      | mJ            |

**NTC Characteristics**  $T_C=25^{\circ}\text{C}$  unless otherwise noted

| Symbol       | Parameter              | Test Conditions                                       | Min. | Typ. | Max. | Unit             |
|--------------|------------------------|---|------|------|------|------------------|
| $R_{25}$     | Rated Resistance       |   |      | 22.0 |      | $\text{k}\Omega$ |
| $\Delta R/R$ | Deviation of $R_{100}$ | $T_C=100^{\circ}\text{C}, R_{100}=1486.1\Omega$       | -5   |      | 5    | %                |
| $P_{25}$     | Power Dissipation      |   |      |      | 200  | mW               |
| $B_{25/50}$  | B-value                | $R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$ |      | 4000 |      | K                |

**Module Characteristics**  $T_C=25^{\circ}\text{C}$  unless otherwise noted

| Symbol     | Parameter                          | Min. | Typ.  | Max.  | Unit |
|------------|------------------------------------|------|-------|-------|------|
| $R_{thJC}$ | Junction-to-Case (per Q1/Q4 IGBT)  |      |       | 0.157 | K/W  |
|            | Junction-to-Case (per Q2/Q3 IGBT)  |      |       | 0.178 |      |
|            | Junction-to-Case (per D1-D4 Diode) |      |       | 0.378 |      |
|            | Junction-to-Case (per D5,D6 Diode) |      |       | 0.165 |      |
| $R_{thCH}$ | Case-to-Heatsink (per Q1/Q4 IGBT)  |      | 0.066 |       | K/W  |
|            | Case-to-Heatsink (per Q2/Q3 IGBT)  |      | 0.086 |       |      |
|            | Case-to-Heatsink (per D1-D4 Diode) |      | 0.186 |       |      |
|            | Case-to-Heatsink (per D5,D6 Diode) |      | 0.087 |       |      |
| M          | Mounting Torque, Screw:M5          | 3.0  |       | 5.0   | N.m  |
| G          | Weight of Module                   |      | 250   |       | g    |

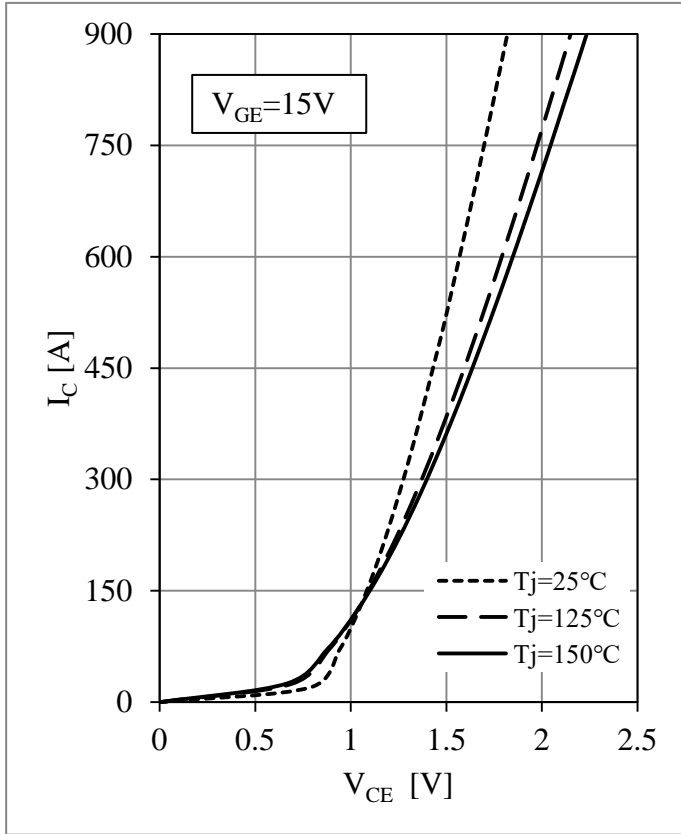


Fig 1. Q1/Q4 IGBT Output Characteristics

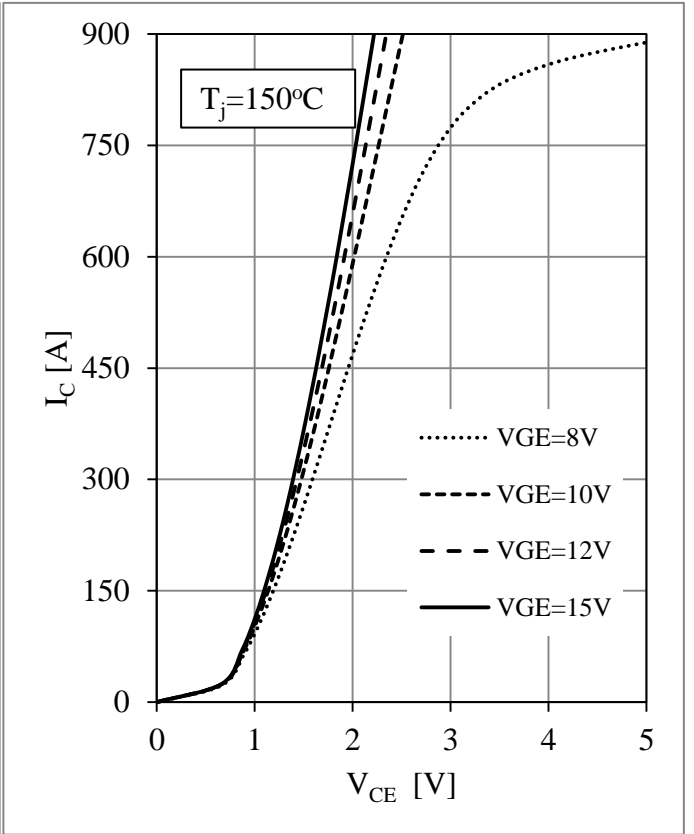


Fig 2. Q1/Q4 IGBT Output Characteristics

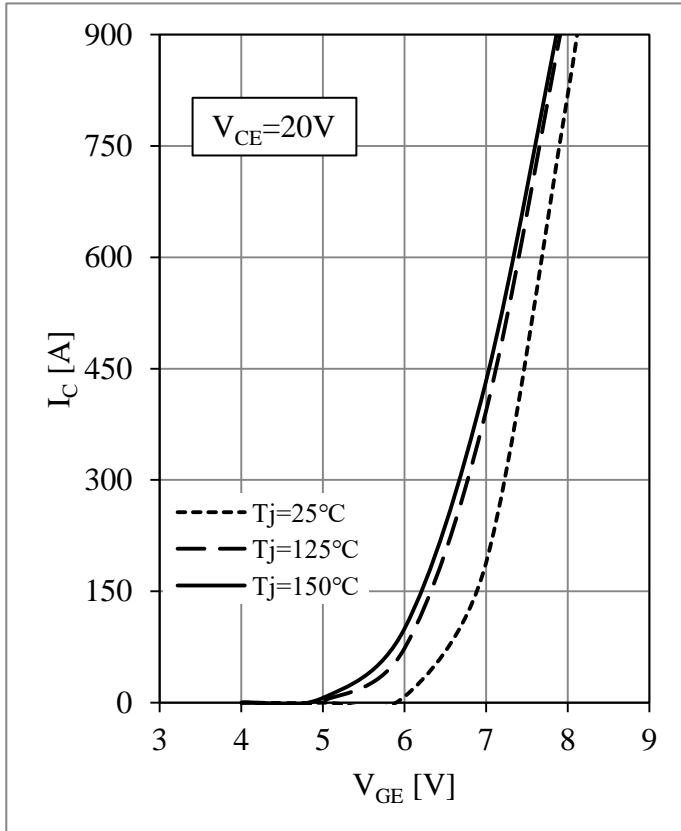


Fig 3. Q1/Q4 IGBT Transfer Characteristics

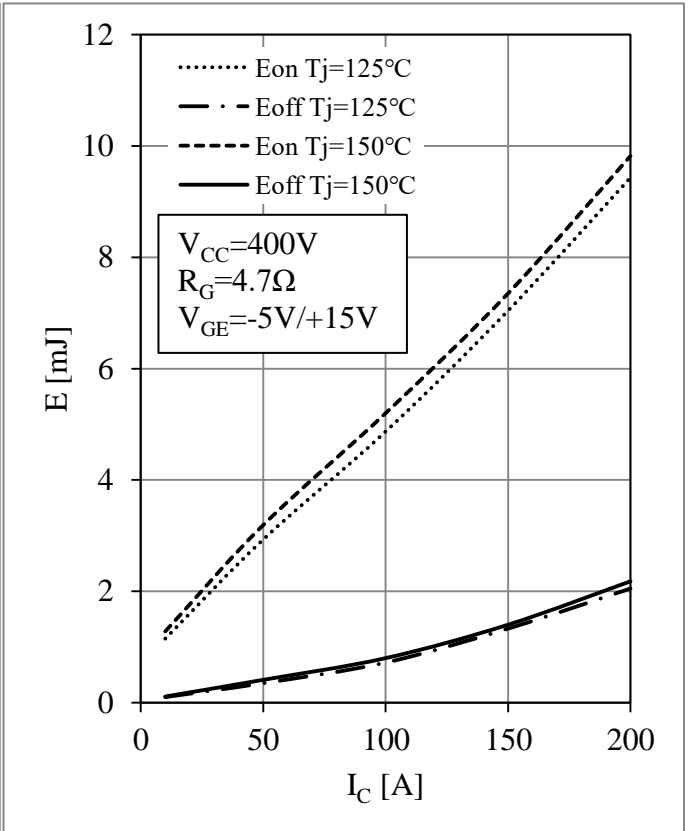


Fig 4. Q1/Q4 IGBT Switching Loss vs.  $I_c$

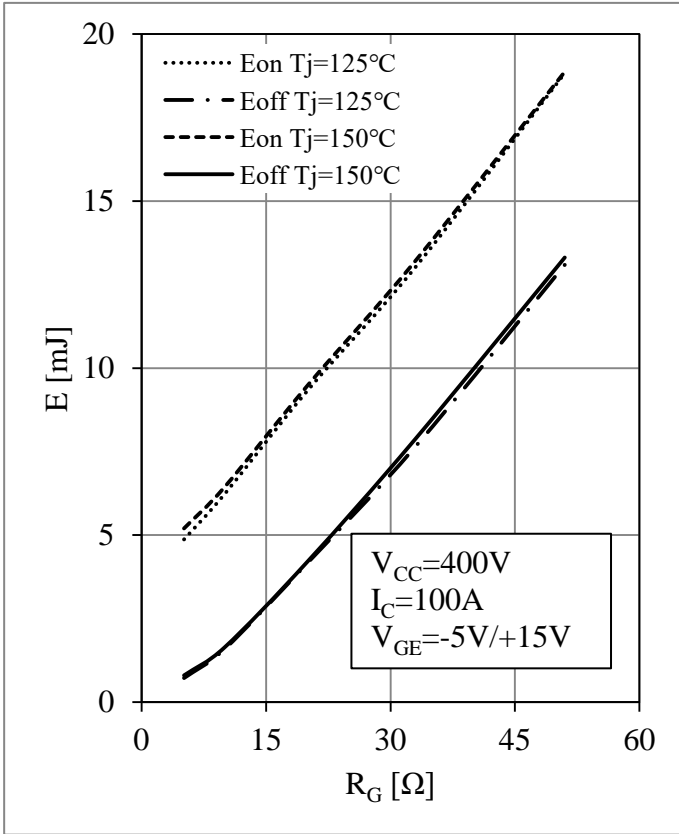


Fig 5. Q1/Q4 IGBT Switching Loss vs. RG

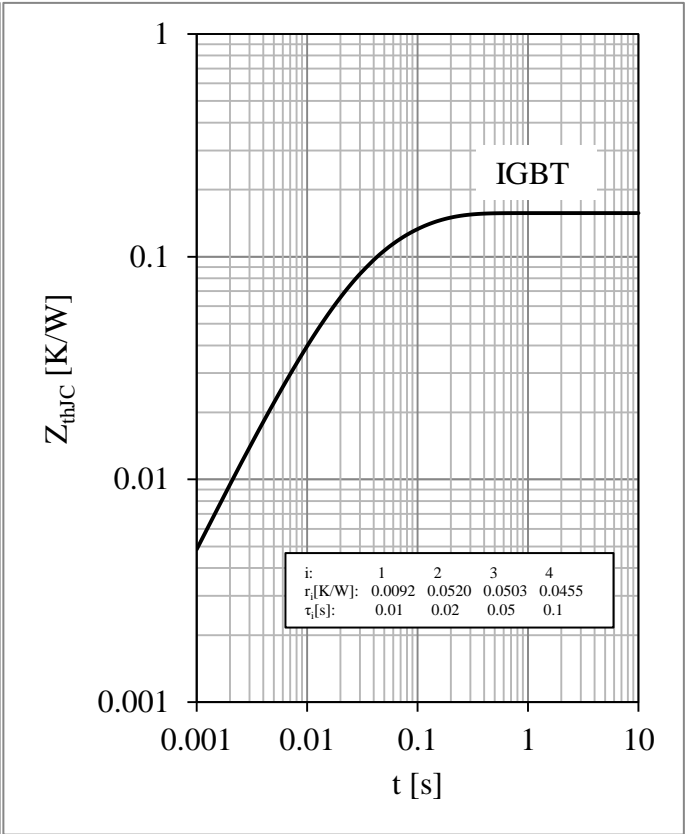


Fig 6. Q1/Q4 IGBT Transient Thermal Impedance

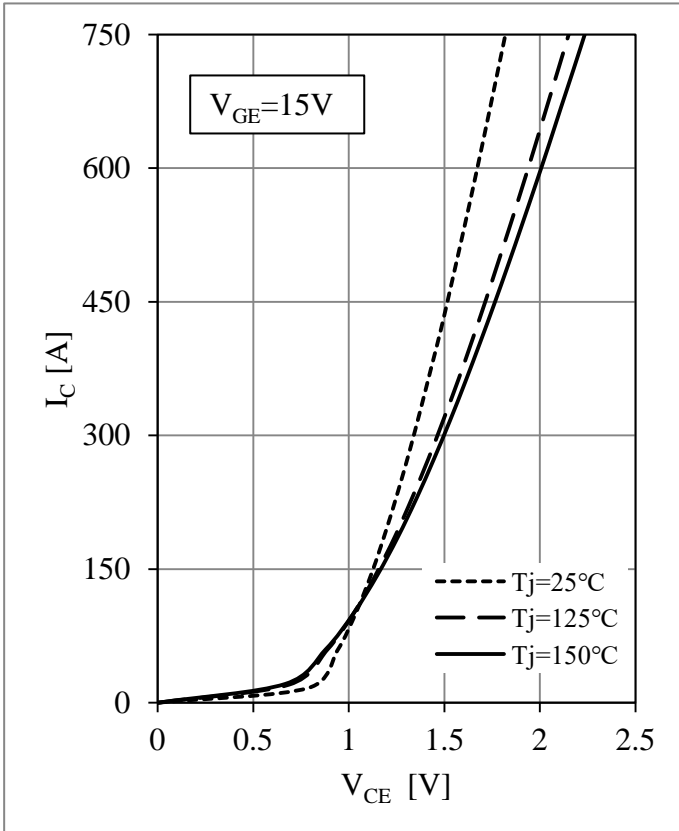


Fig 7. Q2/Q3 IGBT Output Characteristics

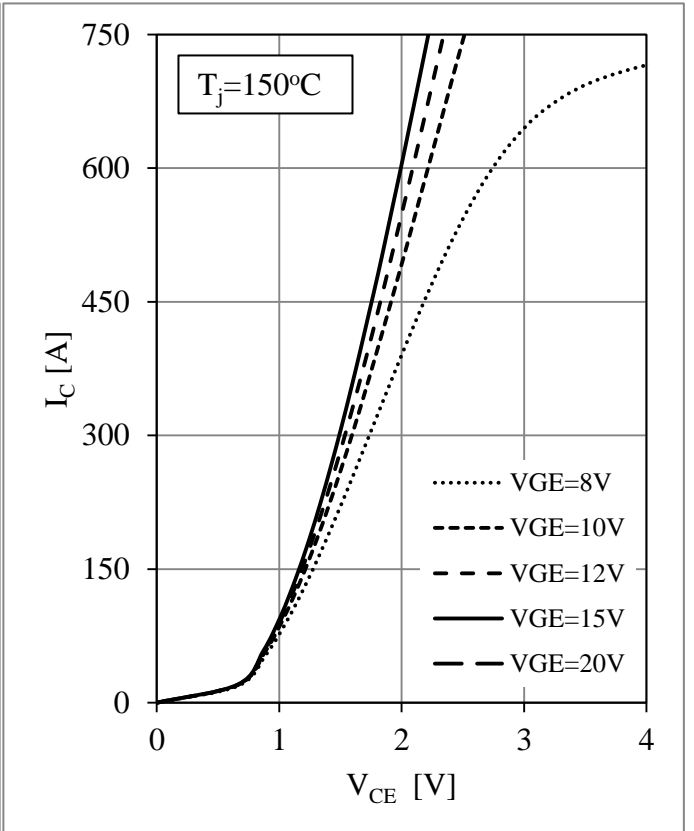


Fig 8. Q2/Q3 IGBT Output Characteristics



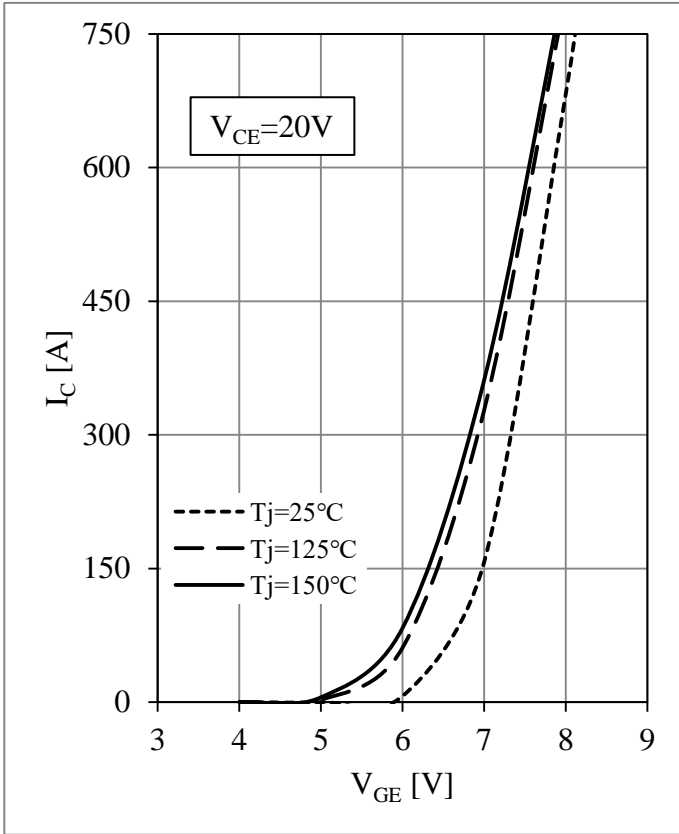


Fig 9. Q2/Q3 IGBT Transfer Characteristics

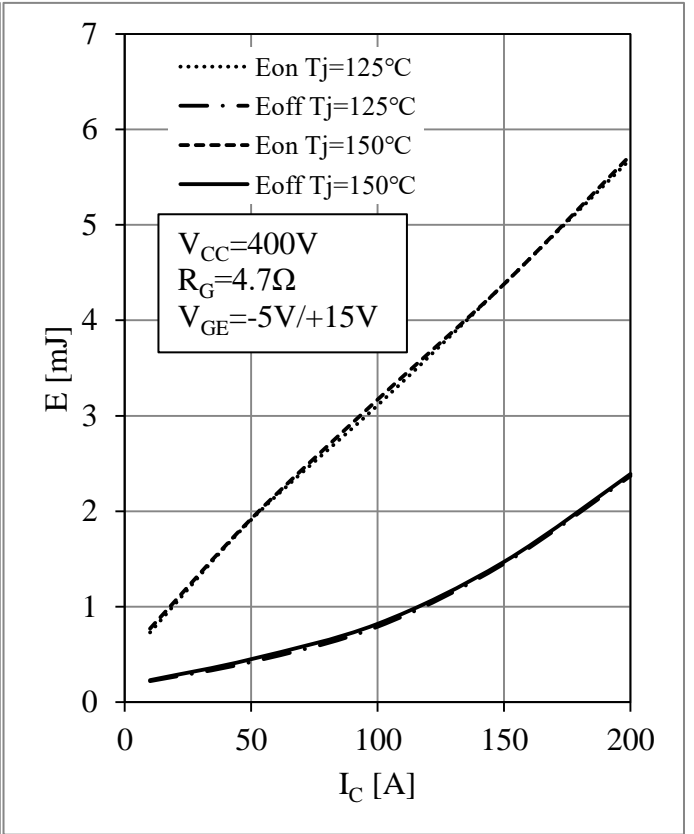


Fig 10. Q2/Q3 IGBT Switching Loss vs.  $I_C$

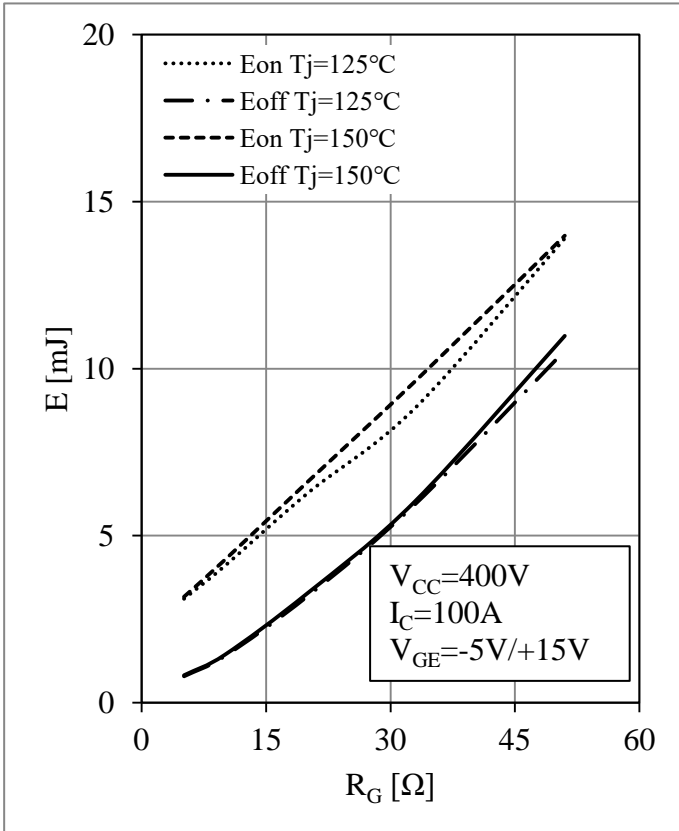


Fig 11. Q2/Q3 IGBT Switching Loss vs.  $R_G$

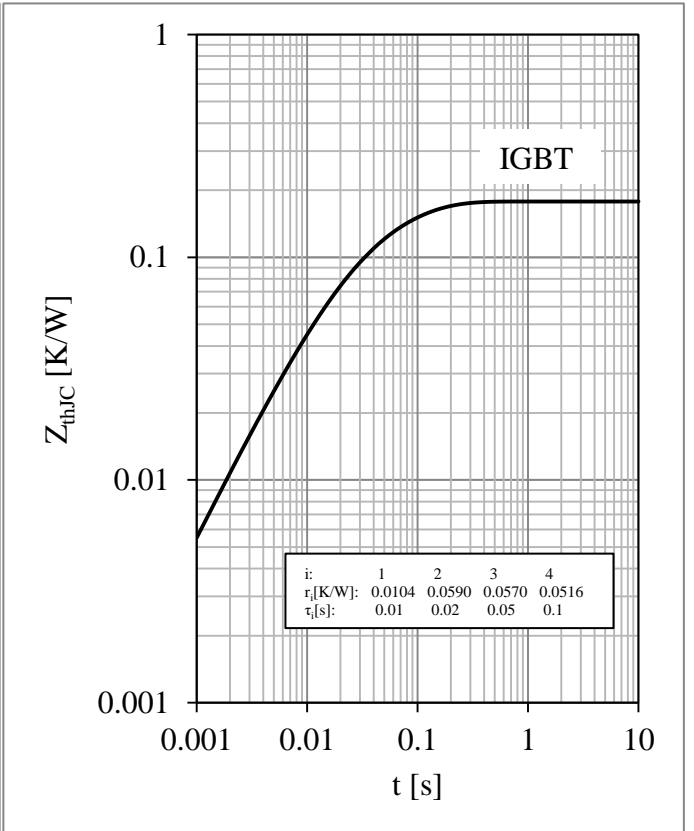


Fig 12. Q2/Q3 IGBT Transient Thermal Impedance

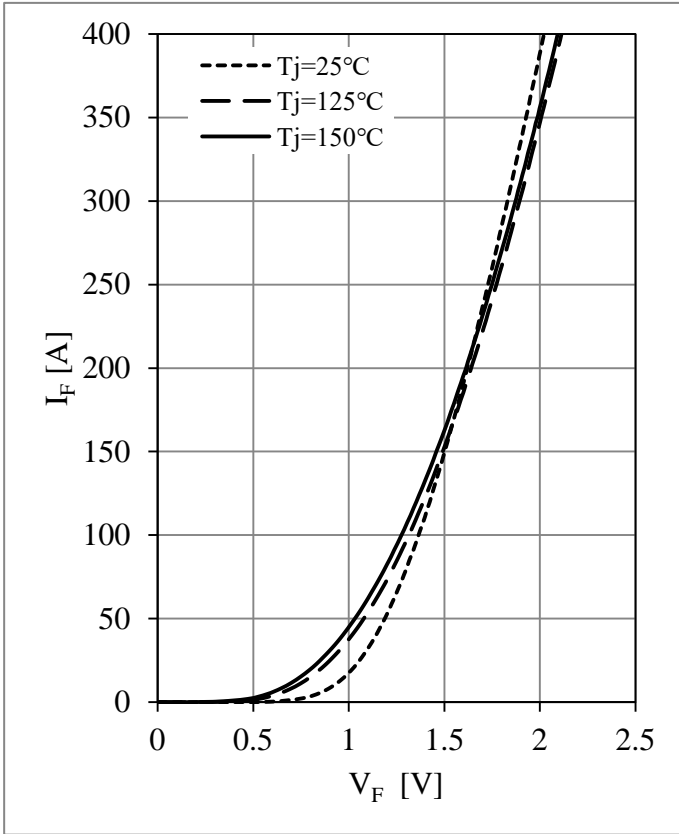


Fig 13. D1-D4 Diode Forward Characteristics

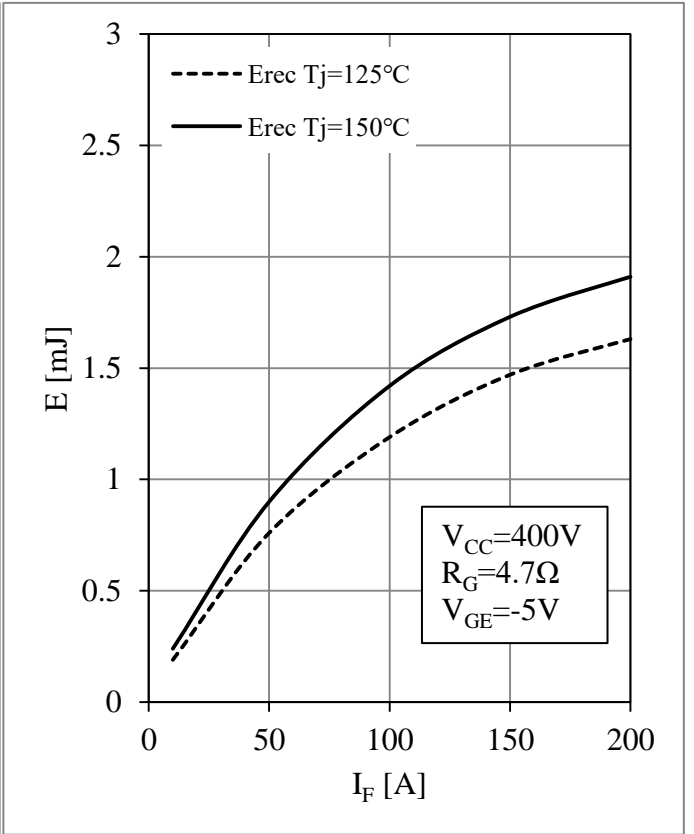


Fig 14. D1-D4 Diode Switching Loss vs.  $I_F$

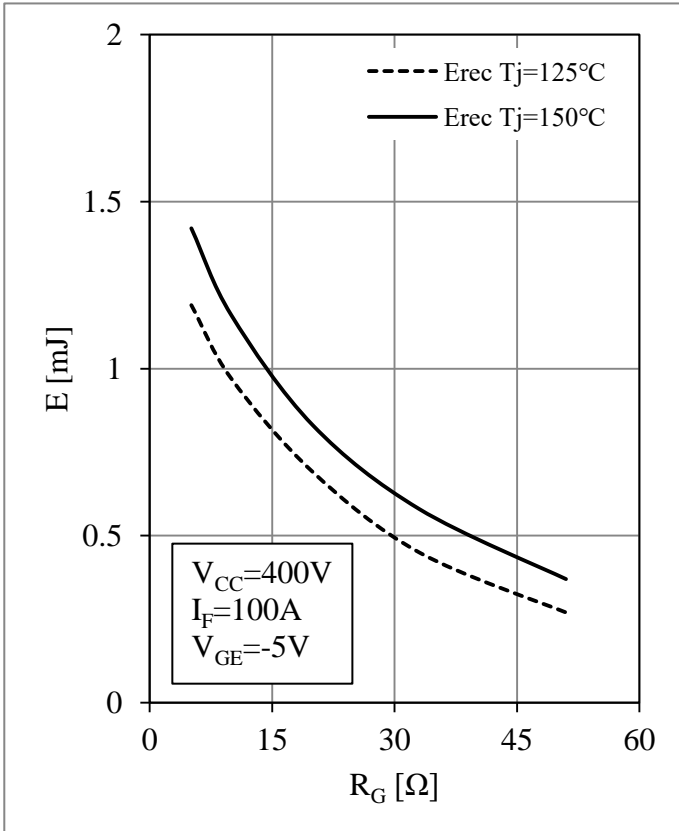


Fig 15. D1-D4 Diode Switching Loss vs.  $R_G$

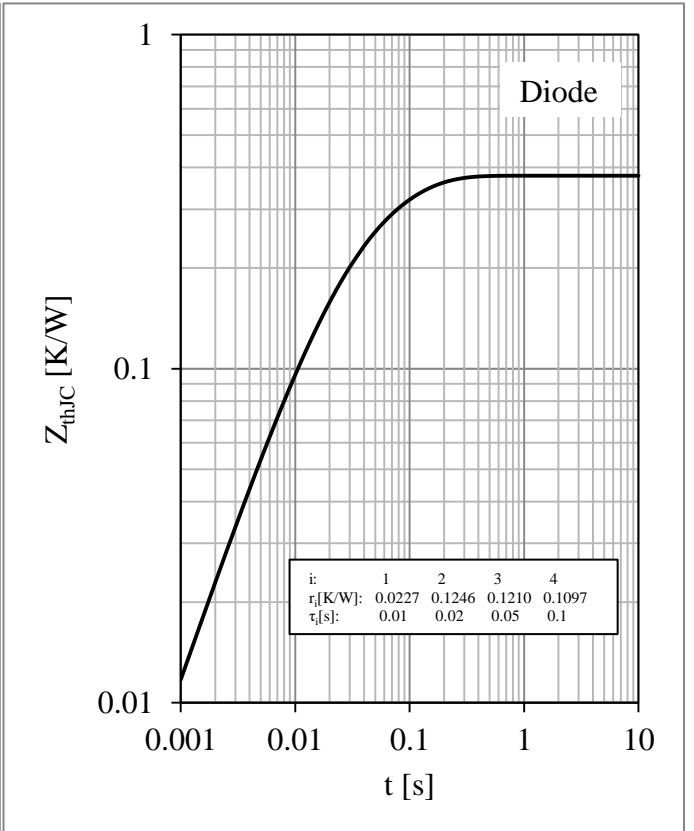


Fig 16. D1-D4 Diode Transient Thermal Impedance

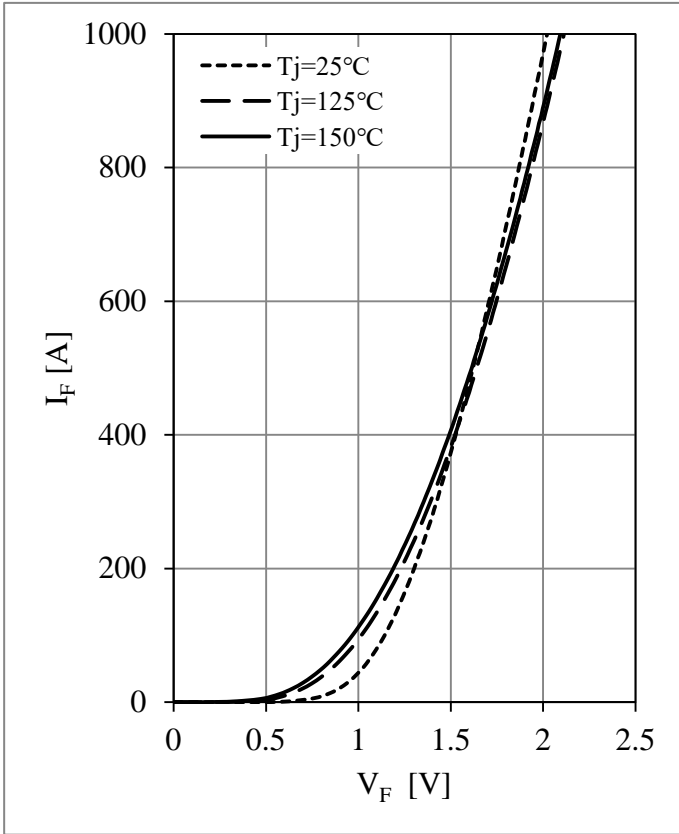


Fig 17. D5/D6 Diode Forward Characteristics

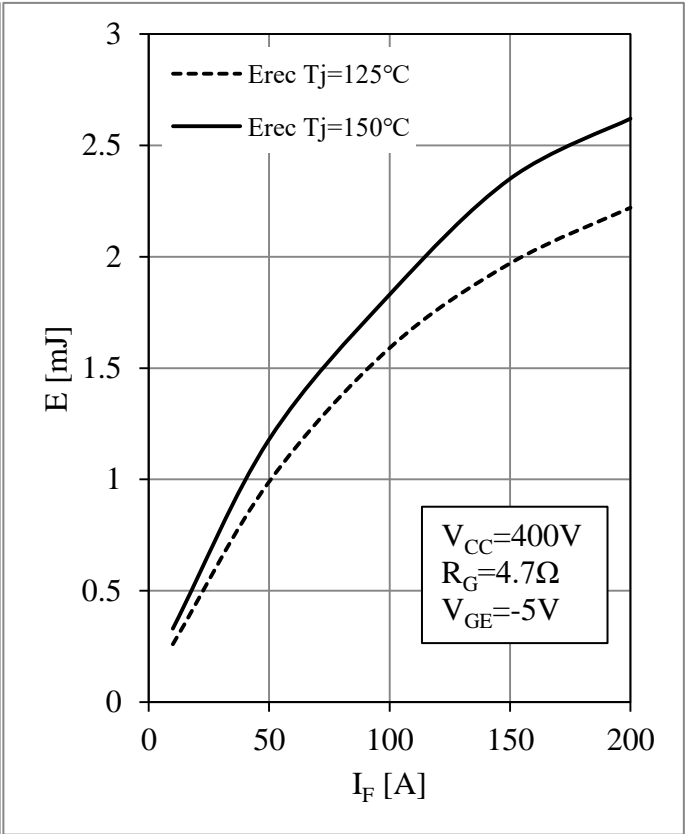


Fig 18. D5/D6 Diode Switching Loss vs.  $I_F$

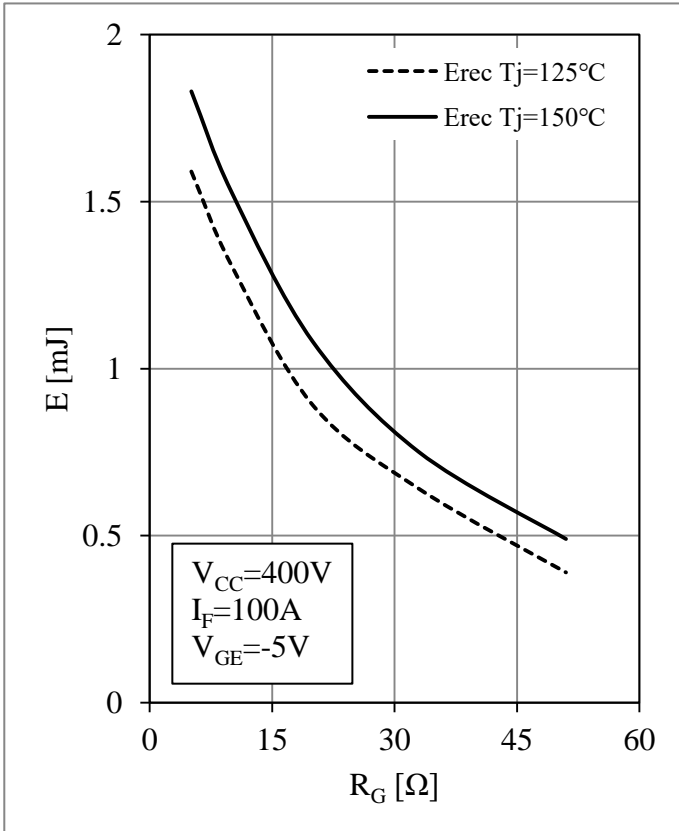


Fig 19. D5/D6 Diode Switching Loss vs.  $R_G$

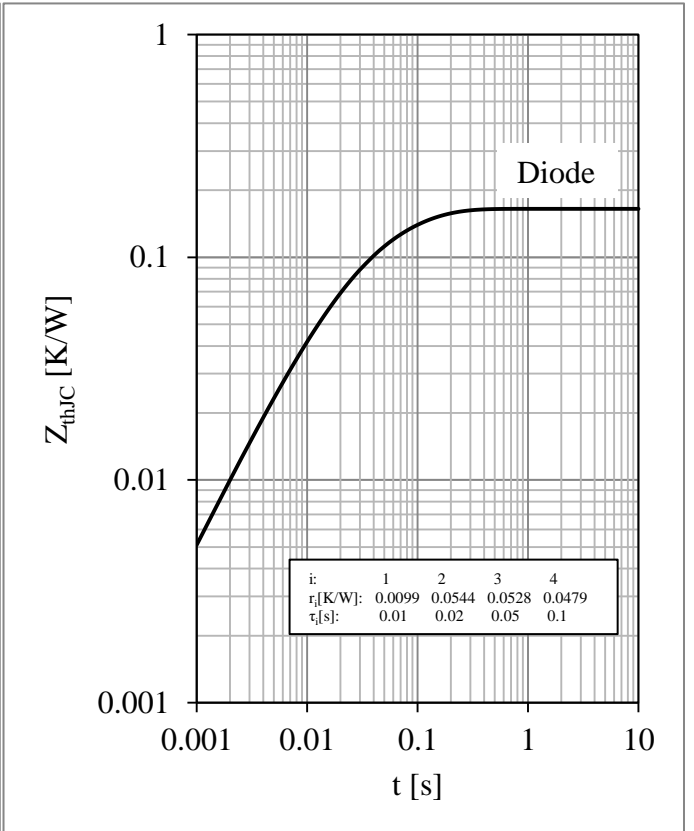


Fig 20. D5/D6 Diode Transient Thermal Impedance

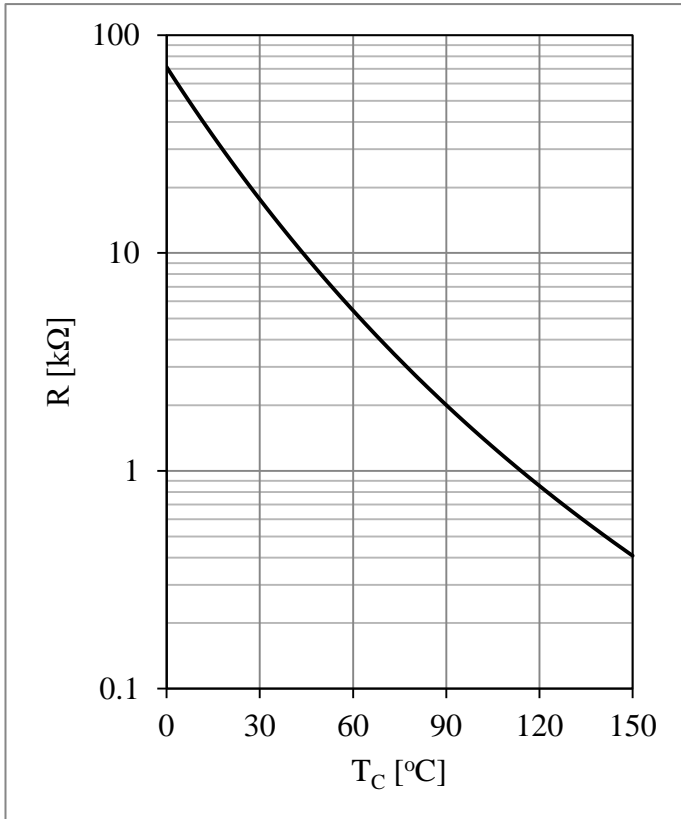
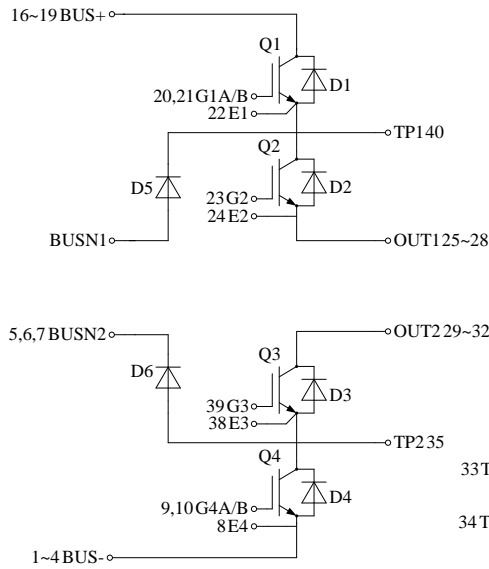


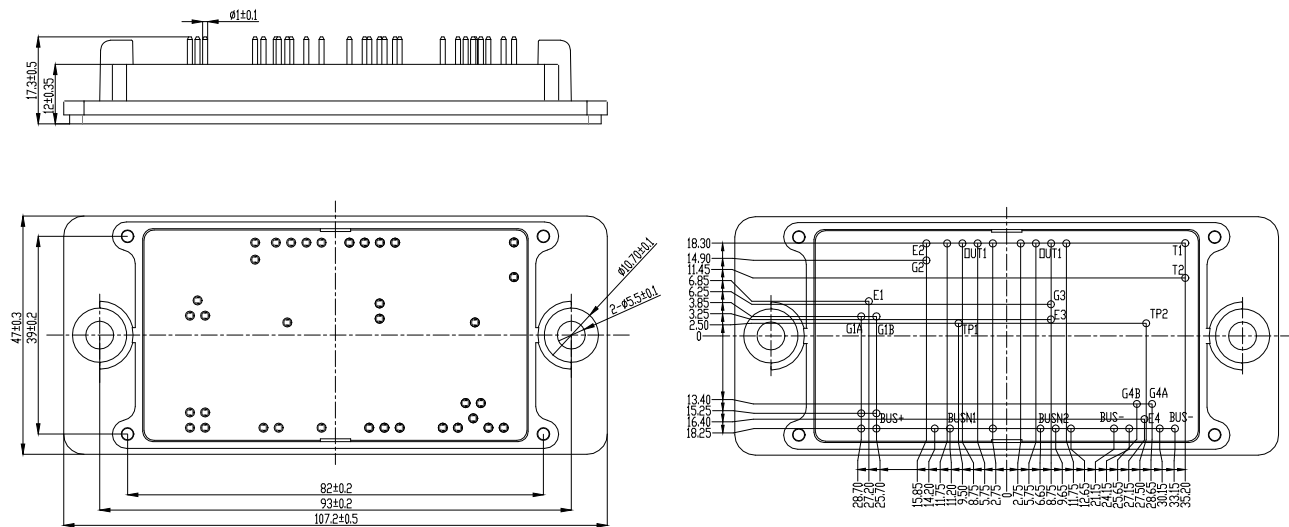
Fig 21. NTC Temperature Characteristic

### Circuit Schematic



### Package Dimensions

Dimensions in Millimeters



## Terms and Conditions of Usage

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